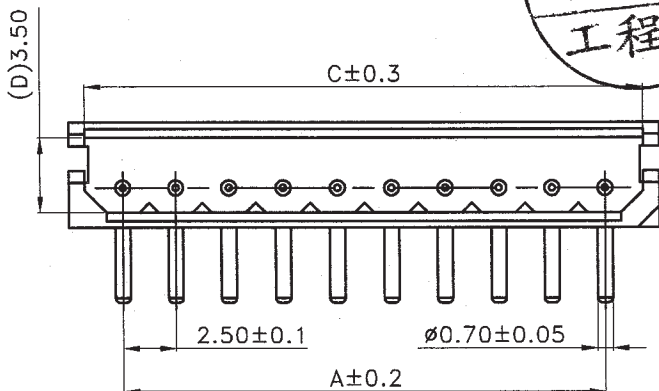
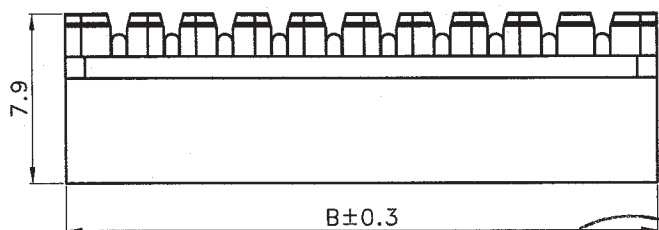
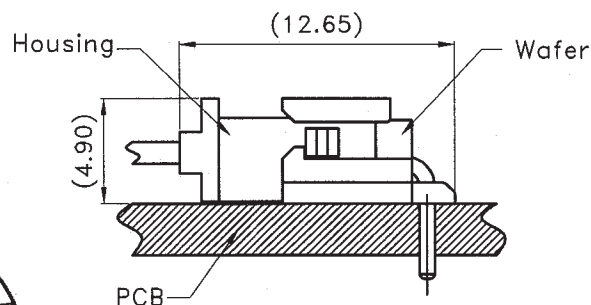
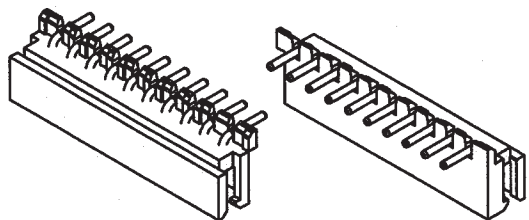


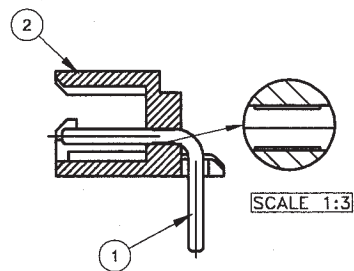
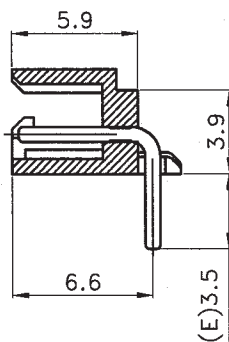
Recommended PCB Layout(Top View)



出圖
100, 5.27
工程部



Assembly Layout (REF.)



Holding Construction Type

■ SPECIFICATIONS

- Current Rating : 3A AC/DC
- Withstanding Voltage : 1,000V AC/minute
- Insulation Resistance : 1,000M Ω min
- Temperature Range : - 25°C to + 85°C
- Contact Resistance : 20m Ω max

■ WAFER

- Part No. : JS-1135R-XXX(XXXX)

Blank : Standard
Construction
S : Holding Construction
Plated Blank : Tin Plated
N2 : Tin Plated(Ni 60u" + Sn 150u")

Plastic
Blank : PA 66 V-2
V0 : PA 66 V-0
GF : PA 66 V-0+G.F.


- Poles : 1.JS-1135R-XX: 2 - 15(Right Angle)
2.JS-1135R-XX(GFN2): 2 - 8(Right Angle)
3.JS-1135R-XX(N2):2 - 15(Right Angle)
- Material : 1.Contact : Brass
2. Base : Refer the above narrative
- Mating Housing : JS-1136-XX
- Mating Terminal : JS-1136-T
- Q' ty : 1,000 pcs./Bag

Poles	Dimensions (mm)		
	A	B	C
2	2.50	7.50	6.00
3	5.00	10.00	8.50
4	7.50	12.50	11.00
5	10.00	15.00	13.50
6	12.50	17.50	16.00
7	15.00	20.00	18.50
8	17.50	22.50	21.00
9	20.00	25.00	23.50
10	22.50	27.50	26.00
11	25.00	30.00	28.50
12	27.50	32.50	31.00
13	30.00	35.00	33.50
14	32.50	37.50	36.00
15	35.00	40.00	38.50

 喬訊電子工業股份有限公司
CHYAO SHIUNN
ELECTRONIC INDUSTRIAL LTD.

PART NO JS-1135R-XXX(XXXX)

2.50mm Crimp Style Connectors Wafer

APPROVED BY	SCALE	UNIT	TOLERANCE	LTR	REVISION RECORD	NAME	DATE	LTR	REVISION RECORD	NAME	DATE
張育瑞		mm	.0 ±0.30	▲				▲			
CHECKED BY	PROJ	VER NO.	.00 ±0.20	▲				▲			
黃科源		a5	.000 ±0.10	▲				▲			
DRAWN BY	DATE	SIZE	ANGLE	▲				▲			
劉怡萱	2011/05/24	A4	0° ±1°	▲	將其他變異體料號融合為一張圖	劉怡萱	11/05/24	▲			
			.0° ±	▲				▲			
			SHEET 1/1	▲				▲			

CUSTOMER

Conforms to The RoHS Instruction